SN54LS323, SN74LS323 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

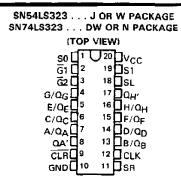
SDLS160

OCTOBER 1976 - REVISED MARCH 1988

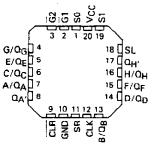
 Multiplexed Inputs/Outputs Provide Improved Bit Density

Four Modes of Operation:
 Hold (Store) Shift Left
 Shift Right Load Data

- . Operates with Outputs Enabled or at High Z
- 3-State Outputs Drive Bus Lines Directly
- Can Be Cascaded for N-Bit Word Lengths
- Typical Power Dissipation . . . 175 mW
- Exceptionally Stable Shift (Clock)
 Frequency . . . 25 MHz
- Applications:
 Stacked or Push-Down Registers,
 Buffer Storage, and
 Accumulator Registers
- SN54LS299 and SN74LS299 Are Similar But Have Direct Overriding Clear



SN54LS323 . . . FK PACKAGE (TOP VIEW)



description

These Low-Power Schottky eight-bit universal registers feature multiplexed inputs/outputs to achieve full eight-bit data handling in a single 20-pin package. Two function-select inputs and two output-control inputs can be used to choose the modes of operation listed in the function table. Synchronous parallel loading is accomplished by taking both function-select lines, S0 and S1, high. This places the three-state outputs in a high-impedance state, which permits data that is applied on the input/output lines to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. The clear function is synchronous, and a low level at the clear input clears the register on the next low-to-high transition of the clock.

FUNCTION TABLE

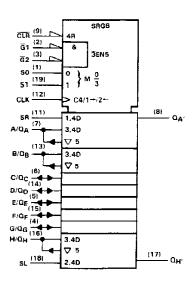
MODE	INPUTS							INPUTS/OUTPUTS						OUTPUTS				
	CLR	FUNCTION SELECT		CONTROL		ÇLK	SERIAL		A/Q _A	B/Qg	c/ac	D/QD	E/Qr	F/Q _F	G/0c	н/он	Q _A ,	Ω _H ′
		S1	S0	Ğ1 [†]	G2†		SL	SA		_	·	_	-	,	_	•	"	••
Clear	L	х	L	L	٢	Ť	×	Х	١	L,	L		L	L	L	Ļ	L	L
	L	L	×	L	L	t	×	×	Ł.	L	L	L	L	L	Ļ	L	ار	L
	L	_ н	Н	Х	х	†	X	X	х	х	X	×	X	x	×	×	Ĺ	L
Hold	н	L.	L	L	۲	×	×	х	QAO	OBO	_G C0	000	QEO	QFQ	a_{G0}	Q _{H0}	Q _{A0}	ано
	н	×	X	L	L	L	×	x		Ω _B 0	aco	Q _{D0}	QE0	QF0			4	
Shift Right	н	L	Н	L	L	1	Х	H	Н	Q_{An}	QBn	QCn	Qpn	QE"	Q _{En}	QGn	Н	QGo
	н	L	н	LL.		†	×	L	L	ОАП	QBn	α _{Cn}	α_{Dn}	Ω _{En}	Q_{Fn}		L	a_{Gn}
Shift Left	H	Н	L	L	L	t	н	X	Qgn	Q _{Cn}	αDn	QEn	Q _{Fn}	QGn	QHn	н	QBn	H
	н	н	L	L	L	Ť	L	х	\mathbf{Q}_{Bn}	σ^{Cu}	$\sigma_{D^{11}}$	ι	Qfn	a_{Gn}	Q_{Hn}	L	QBn	L
Load	H	Н	Н	Х	Х	Ť	X	X	a	b	C	ď		f	9	h	a	— <u>h</u>

a...h = the level of the steady-state input at inputs A through H, respectively. These data are loaded into the flip-flops while the flip-flop outputs are isolated from the input/output terminals.



SN54LS323, SN74LS323 **8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS**

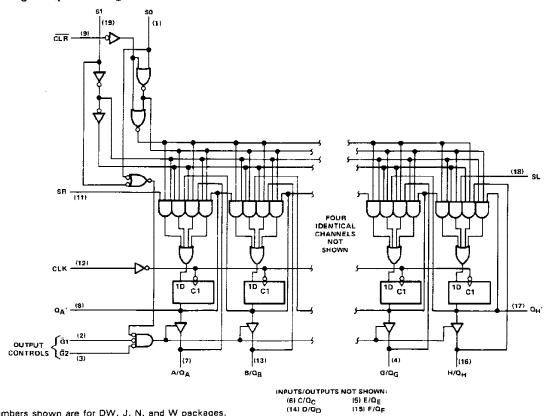
logic symbol†



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, N, and W packages.

logic diagram (positive logic)

Pin numbers shown are for DW, J, N, and W packages.



schematics of inputs and outputs, absolute maximum ratings, recommended operating conditions, and electrical characteristics

Same as SN54LS299 and SN74LS299, except t_{SU} (Clear Inactive) does not apply.

switching characteristics, VCC = 5 V, $T_A = 25^{\circ} \text{ C}$

PARAMETER †	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN 25	TYP 35	MAX	UNIT
f _{max}			See Note 1				
^t PLH	CLK	0.7 54 0.77	0 15.5 0 -0.0		22	33	
[†] PH L	CER	Q _A ' or Q _H '	C _L - 15 pF, R _L = 2 kΩ		26	39	ns
[†] PLH	CLK	Q _A thru Q _H			17	25	ns
tPHL_	CEN	α _A iii α _H	C - 45 oF B - 655 O		25	39	
^t PZH	Ğ1, Ğ2	Q _A thru Q _H	CL = 45 pF, ΗL = 665 Ω		14	21	ns
tPZL	31, 42	α _A tilla α _H			20	30	
^t PHZ	Ğ1, Ğ2	Q _A thru Q _H	C		10	20	
tPLZ] 31, 02	од или од	CL = 5 pF, RL = 665 մ		10	15	ns

†t_{max} = maximum clock frequency tp_{LH} = Propagation delay time, low-to-high-level output

tpHL = Propagation delay time, high-to-low-level output

tpzH = Output enable time to high level

tpzL = Output enable time to low level

tpHZ = Output disable time from high level

tpl 7 = Output disable time from low level

NOTE 1: For testing f_{max}, all outputs are loaded simultaneously, each with C_L and R_L as specified for the propagation times. Load circuits and voltage waveforms are shown in Section 1.

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